

**PATENT**

**IN THE UNITED STATES PATENT AND TRADEMARK OFFICE**

**In re Application of:**

Derderian et al.

**Serial No.:** 10/787,450

**Filed:** February 26, 2004

**For:** METHOD OF FORMING AN  
INTERFACE FOR A SEMICONDUCTOR  
DEVICE (AS AMENDED)

**Confirmation No.:** 7825

**Examiner:** J. Maldonado

**Group Art Unit:** 2823

**Attorney Docket No.:** 2269-4097.1US  
(97-1252.01/US)

**Notice of Allowance Mailed:**

March 22, 2007

**VIA ELECTRONIC FILING  
JUNE 15, 2007**

**AMENDMENT PURSUANT TO 37 C.F.R. § 1.312(a)**

Mail Stop ISSUE FEE  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, Virginia 22313-1450

Sir:

Please amend the above-referenced application as follows:

Amendments to the specification begin on page 3 of this paper;